## High-speed electronics HT2019 – Exercise 3

## "Transistor AC and Noise"

- 1. Consider an NQS InGaAs FET with  $C_{GS}$ =10fF,  $g_m$ =20 mS,  $R_g$ =5 $\Omega$  and  $\gamma = 1$ .
  - a. Calculate the minimum noise figure and optimum noise impedance for f=10 GHz and f=94 GHz.
  - b. If the transistor is connected directly to a 50 $\Omega$  source. What is the corresponding noise figure,  $NF_{50}$ ?
  - c. Estimate the smallest voltage signal that the transistor can accurately amplify (when connected to a very low impedance voltage source), assuming a low frequency  $(\omega RC \ll 1)$  signal bandwidth of  $\Delta f$ =1MHz.
  - d. A 50 $\Omega$  resistor is placed in parallel to  $C_{GS}$ . What is the minimum noise figure (at  $f \approx 0 Hz$ ) for this device augmented with the 50 $\Omega$  resistor? Adding resistances to the device input is typically *NOT* a good idea in terms of noise performance!
- 2. Calculate  $C_{GS}$  (fF/ $\mu$ m) per unit gate width (in saturation) for HEMTs with channels of
  - a) InAs
  - b) In<sub>0.53</sub>Ga<sub>0.47</sub>As
  - c) GaN

Assume  $L_g$ =20 nm,  $t_w$ =8 nm,  $t_{ox}$ =5 nm,  $\varepsilon_{rox}$ =25.

- d) Which device of a-c should have the highest I<sub>DS</sub> given that there is no scattering?
- 3. Given the following circuit,



- a) Calculate the y-parameter matrix
- b) Calculate the z-parameter matrix from the y-matrix
- c) Now add parasitic resistances to the system (as shown below) and calculate the z-matrix of the full system. Assume  $R_{SD} = R_G/2 = R$ .



d) Transform the circuit into a hybrid- $\pi$  model.